

LOW VOLTAGE 0.5Ω MAX QUAD SPDT SWITCH WITH BREAK BEFORE MAKE FEATURE

- HIGH SPEED:
 $t_{PD} = 0.3\text{ns}$ (TYP.) at $V_{CC} = 3.0\text{V}$
 $t_{PD} = 0.4\text{ns}$ (TYP.) at $V_{CC} = 2.3\text{V}$
- ULTRA LOW POWER DISSIPATION:
 $I_{CC} = 0.2\mu\text{A}$ (MAX.) at $T_A = 85^\circ\text{C}$
- LOW "ON" RESISTANCE $V_{IN}=0\text{V}$:
 $R_{ON} = 0.5\Omega$ (MAX. $T_A = 25^\circ\text{C}$) at $V_{CC} = 2.7\text{V}$
 $R_{ON} = 0.8\Omega$ (MAX. $T_A = 25^\circ\text{C}$) at $V_{CC} = 2.3\text{V}$
 $R_{ON} = 3.0\Omega$ (MAX. $T_A = 25^\circ\text{C}$) at $V_{CC} = 1.8\text{V}$
- WIDE OPERATING VOLTAGE RANGE:
 V_{CC} (OPR) = 1.65V to 4.3V SINGLE SUPPLY
- 4.3V TOLERANT AND 1.8V COMPATIBLE THRESHOLD ON DIGITAL CONTROL INPUT at $V_{CC} = 2.3$ to 3.0V
- LATCH-UP PERFORMANCE EXCEEDS 300mA (JESD 17)
- ESD PERFORM. (ANALOG CHAN. vs GND): HBM > 7KV (MIL STD 883 method 3015)

DESCRIPTION

The STG3699 is an high-speed CMOS LOW VOLTAGE QUAD ANALOG S.P.D.T. (Single Pole Dual Throw) SWITCH or 2:1 Multiplexer/Demultiplexer Switch fabricated in silicon gate C²MOS technology. It is designed to operate from 1.65V to 4.3V, making this device ideal for portable applications.

It offers very low ON-Resistance (<0.5Ω) at $V_{CC}=3.0\text{V}$. The nIN inputs are provided to control the switches. The switches nS1 are ON (they are

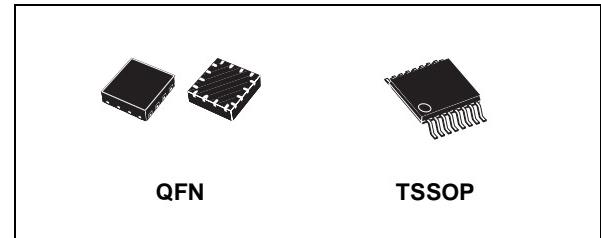


Table 1: Order Codes

PACKAGE	T & R
TSSOP	STG3699TTR
QFN	STG3699QTR

connected to common Ports Dn) when the nIN input is held high and OFF (high impedance state exists between the two ports) when nIN is held low; the switches nS2 are ON (they are connected to common Ports Dn) when the nIN input is held low and OFF (high impedance state exists between the two ports) when IN is held high. Additional key features are fast switching speed, Break Before Make Delay Time and Ultra Low Power Consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage. It's available in the commercial temperature range in TSSOP and QFN3x3mm package.

Figure 1: Pin Connection

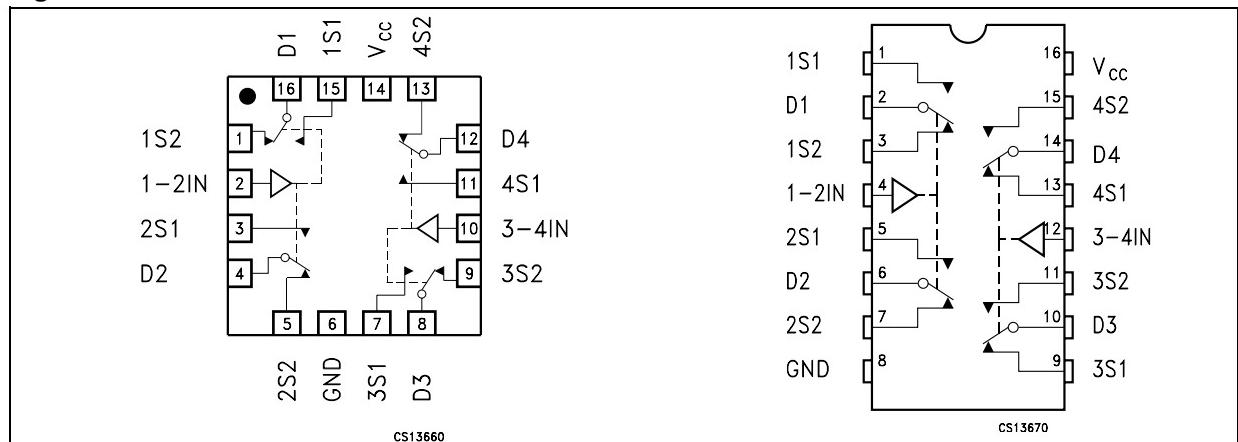
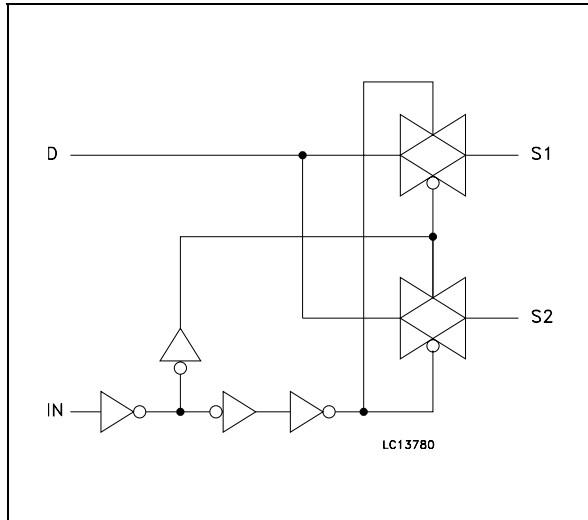


Figure 2: Input Equivalent Circuit**Table 2: Pin Description**

TSSOP ⁽¹⁾ PIN N°	QFN ⁽¹⁾ PIN N°	SYMBOL	NAME AND FUNCTION
1, 5, 9, 13, 3, 7, 11, 15	15, 3, 7, 11, 1, 5, 9, 13	1S1 to 4S1, 1S2 to 4S2	Independent Channels
2, 6, 10, 14	16, 4, 8, 12	D1 to D4	Common Channels
4, 12	2, 10	1-2IN, 3-4IN	Controls
16	14	V _{CC}	Positive Sup- ply Voltage
8	6	GND	Ground (0V)

1. Exposed pad must be soldered to a floating plane. Do NOT connect to power or ground.

Table 3: Truth Table

IN	SWITCH S1	SWITCH S2
H	ON	OFF ⁽¹⁾
L	OFF ⁽¹⁾	ON

1. High Impedance

Table 4: Absolute Maximum Ratings

Symbol	Parameter		Value	Unit
V _{CC}	Supply Voltage		-0.5 to 4.6	V
V _I	DC Input Voltage		-0.5 to V _{CC} + 0.5	V
V _{IC}	DC Control Input Voltage		-0.5 to 4.6	V
V _O	DC Output Voltage		-0.5 to V _{CC} + 0.5	V
I _{IKC}	DC Input Diode Current on control pin (V _{IN} < 0V)		-50	mA
I _{IK}	DC Input Diode Current (V _{IN} < 0V)		± 50	mA
I _{OK}	DC Output Diode Current		± 20	mA
I _O	DC Output Current		± 300	mA
I _{OP}	DC Output Current Peak (pulse at 1ms, 10% duty cycle)		± 500	mA
I _{CC} or I _{GND}	DC V _{CC} or Ground Current		± 100	mA
P _D	Power Dissipation at T _a =70°C (1)	QFN TSSOP	1120 500	mW
T _{stg}	Storage Temperature		-65 to 150	°C
T _L	Lead Temperature (10 sec)		300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions not implied.

(1) Derate above 70°C: by 18.5mW/°C for QFN package; by 5.6mW/°C for TSSOP.

Table 5: Recommended Operating Conditions

Symbol	Parameter		Value	Unit
V _{CC}	Supply Voltage (note 1)		1.65 to 4.3	V
V _I	Input Voltage		0 to V _{CC}	V
V _{IC}	Control Input Voltage		0 to 4.3	V
V _O	Output Voltage		0 to V _{CC}	V
T _{op}	Operating Temperature		-55 to 125	°C
dt/dv	Input Rise and Fall Time Control Input		V _{CC} = 1.65V to 2.7V 0 to 20	ns/V
			V _{CC} = 3.0V to 4.3V 0 to 10	

1) Truth Table guaranteed: 1.2V to 4.3V.

Table 6: DC Specifications

Symbol	Parameter	Test Conditions		Value						Unit	
		V _{CC} (V)		T _A = 25°C			-40 to 85°C		-55 to 125°C		
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V _{IH}	High Level Input Voltage	1.65-1.95		0.65V _{CC}			0.65V _{CC}		0.65V _{CC}		V
		2.3-2.5		1.4			1.4		1.4		
		2.7-3.0		1.4			1.4		1.4		
		3.3		1.5			1.5		1.5		
		3.6		1.7			1.7		1.7		
		4.3		2.2			2.2		2.2		
V _{IL}	Low Level Input Voltage	1.65-1.95				0.40		0.40		0.40	V
		2.3-2.5				0.50		0.50		0.50	
		2.7-3.0				0.50		0.50		0.50	
		3.3				0.50		0.50		0.50	
		3.6				0.50		0.50		0.50	
		4.3				1.3		1.3		1.3	
R _{ON}	Switch ON Resistance (1)	4.3	V _S =0V to V _{CC} I _S =100mA			0.40	0.50		0.60		Ω
		3.0				0.40	0.50		0.60		
		2.7				0.40	0.50		0.60		
		2.3				0.50	0.80		0.80		
		1.8				0.70	3.0		4.0		
		1.65				0.80	3.0		4.0		
ΔR _{ON}	ON Resistance Match between channels (1,2)	2.7	V _S =1.5V I _S =100mA		0.06						Ω
R _{FLAT}	ON Resistance FLATNESS (3)	4.3	V _S =1.5V I _S =100mA								Ω
		3.0									
		2.7			0.07	0.15		0.15			
		2.3									
		1.65	V _S =0.8V I _S =100mA								
I _{OFF}	OFF State Leakage Current (nSn), (Dn)	4.3	V _S =0.3 or 4V			±10		± 100			nA
I _{IN}	Input Leakage Current	0 - 4.3	V _{IN} = 0 to 4.3V			±0.1		± 1			μA
I _{CC}	Quiescent Supply Current (1)	1.65-4.3	V _{IN} =V _{CC} or GND			±0.05		±0.2		±1	μA

Note 1: Guaranteed by design

Note 2: ΔR_{ON} = R_{ON(MAX)} - R_{ON(MIN)}

Note 3: Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

Table 7: AC Electrical Characteristics ($C_L = 35\text{pF}$, $R_L = 50\Omega$, $t_r = t_f \leq 5\text{ns}$)

Symbol	Parameter	Test Condition		Value								Unit
		V_{CC} (V)		$T_A = 25^\circ\text{C}$			$-40 \text{ to } 85^\circ\text{C}$		$-55 \text{ to } 125^\circ\text{C}$			
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.		
t_{PLH}, t_{PHL}	Propagation Delay	1.65-1.95	$V_I = \text{OPEN}$		0.45							ns
		2.3-2.7			0.40							
		3.0-3.6			0.30							
		3.6-4.3			0.30							
t_{ON}	TURN-ON time	1.65-1.95	$V_S = 0.8\text{V}$		70							ns
		2.3-2.7	$V_S = 1.5\text{V}$		30	50		60				
		3.0-3.6			30	50		60				
		3.6-4.3			30	50		60				
t_{OFF}	TURN-OFF time	1.65-1.95	$V_S = 0.8\text{V}$		45							ns
		2.3-2.7	$V_S = 1.5\text{V}$		25	30		40				
		3.0-3.6			25	30		40				
		3.6-4.3			25	30		40				
t_D	Break Before Make Time Delay	1.65-1.95	$C_L = 35\text{pF}$ $R_L = 50\Omega$ $V_S = 1.5\text{V}$									ns
		2.3-2.7		2	15							
		3.0-3.6		2	15							
		3.6-4.3		2	15							
Q	Charge injection	1.65-1.95	$C_L = 100\text{pF}$ $R_L = 1\text{M}\Omega$ $V_{GEN} = 0\text{V}$ $R_{GEN} = 0\Omega$		50							pC
		2.3-2.7			40							
		3.0-3.6			35							
		3.6-4.3			35							

Table 8: Analog Switch Characteristics ($C_L = 5\text{pF}$, $R_L = 50\Omega$, $T_A = 25^\circ\text{C}$)

Symbol	Parameter	Test Condition		Value								Unit	
		V_{CC} (V)		$T_A = 25^\circ\text{C}$			$-40 \text{ to } 85^\circ\text{C}$		$-55 \text{ to } 125^\circ\text{C}$				
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.			
OIRR	Off Isolation (1)	1.65-4.3	$V_S = 1\text{V}_{\text{RMS}}$ $f = 100\text{kHz}$		-64							dB	
Xtalk	Crosstalk	1.65-4.3	$V_S = 1\text{V}_{\text{RMS}}$ $f = 100\text{kHz}$		-54							dB	
THD	Total Harmonic Distortion	2.3-4.3	$R_L = 600\Omega$ $V_{IN} = 2\text{V}_{\text{PP}}$ $f = 20\text{Hz to } 20\text{kHz}$		0.03							%	
BW	-3dB Bandwidth	1.65-4.3	$R_L = 50\Omega$		50							MHz	
C_{IN}	Control Pin Input Capacitance				5							pF	
C_{Sn}	Sn Port Capacitance	3.3	$f = 1\text{MHz}$		37								
C_D	D Port Capacitance when Switch is Enabled	3.3	$f = 1\text{MHz}$		84								

Note 1: Off Isolation = $20\log_{10}(V_D/V_S)$, V_D = output. V_S = input to off switch

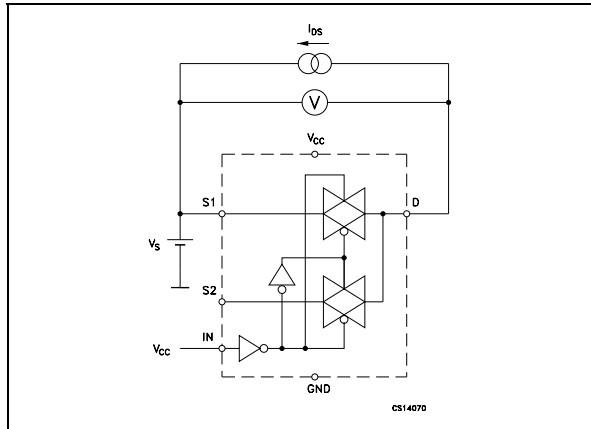
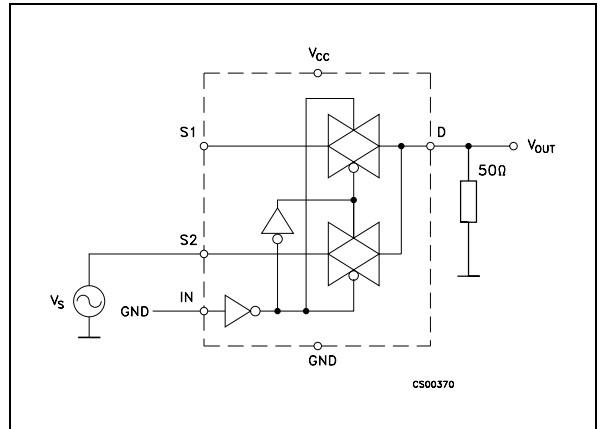
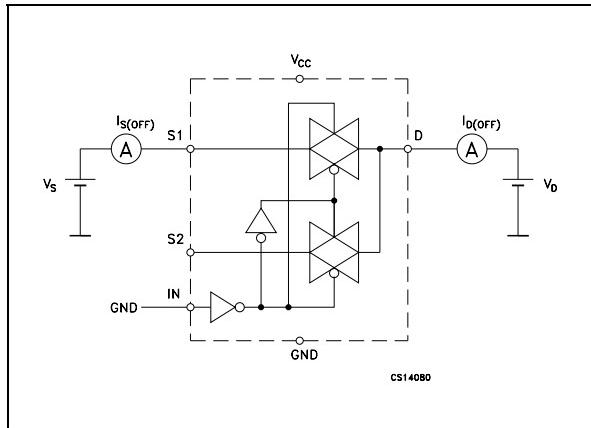
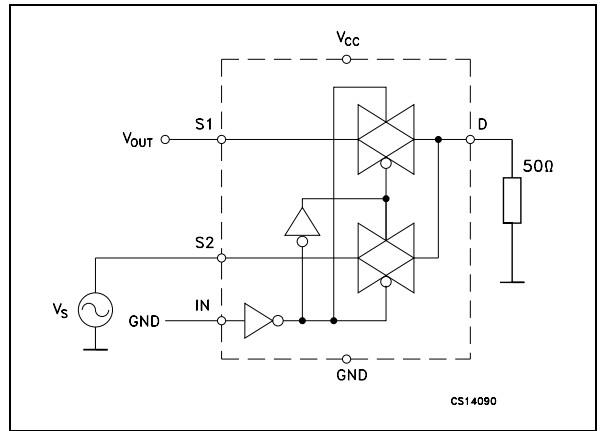
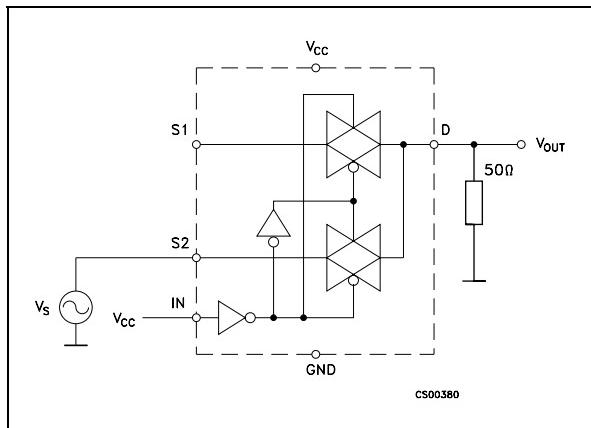
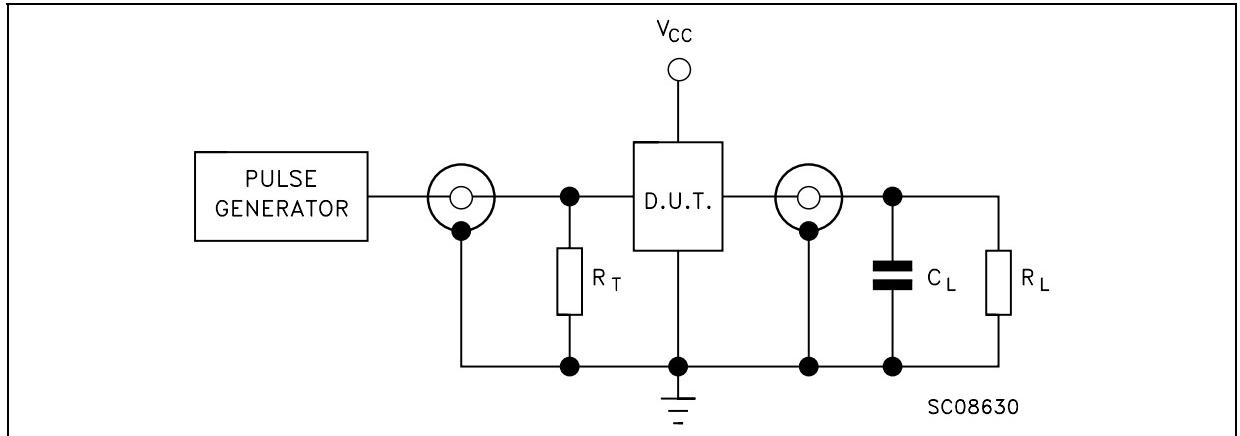
Figure 3: On Resistance**Figure 6: Bandwidth****Figure 4: Off Leakage****Figure 7: Channel To Channel Crosstalk****Figure 5: Off Isolation**

Figure 8: Test Circuit



$C_L = 5/35\text{pF}$ or equivalent (includes jig and probe capacitance)

$R_L = 50\Omega$ or equivalent

$R_T = Z_{OUT}$ of pulse generator (typically 50Ω)

Figure 9: Break Before Make Time Delay

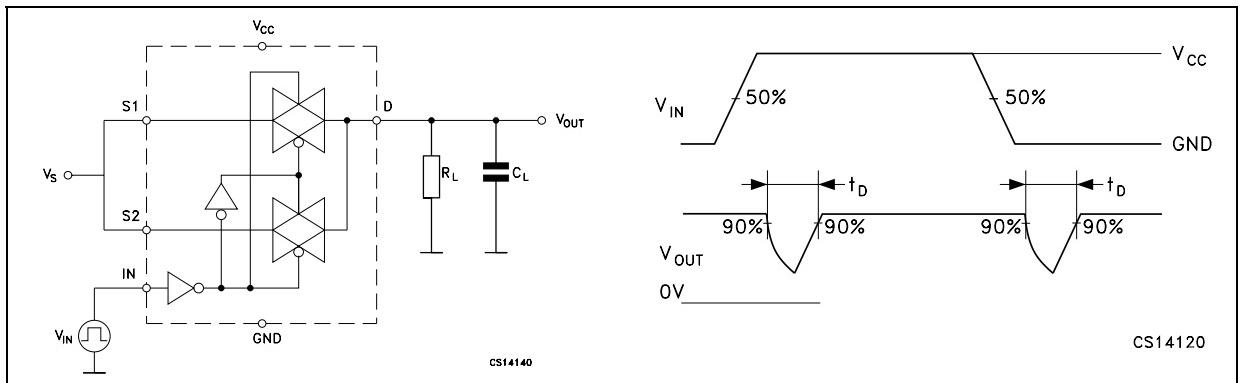


Figure 10: Charge Injection ($V_{GEN}=0V$, $R_{GEN}=0\Omega$, $R_L=1M\Omega$, $C_L=100\text{pF}$)

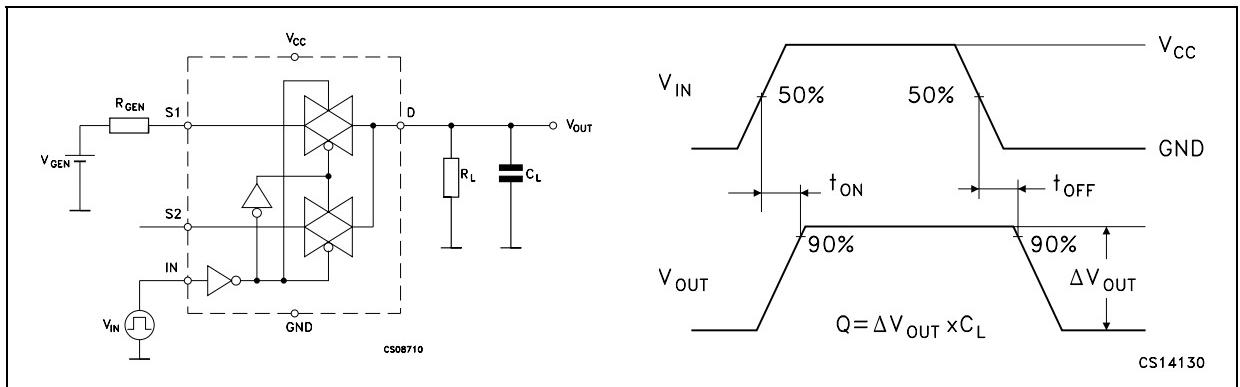
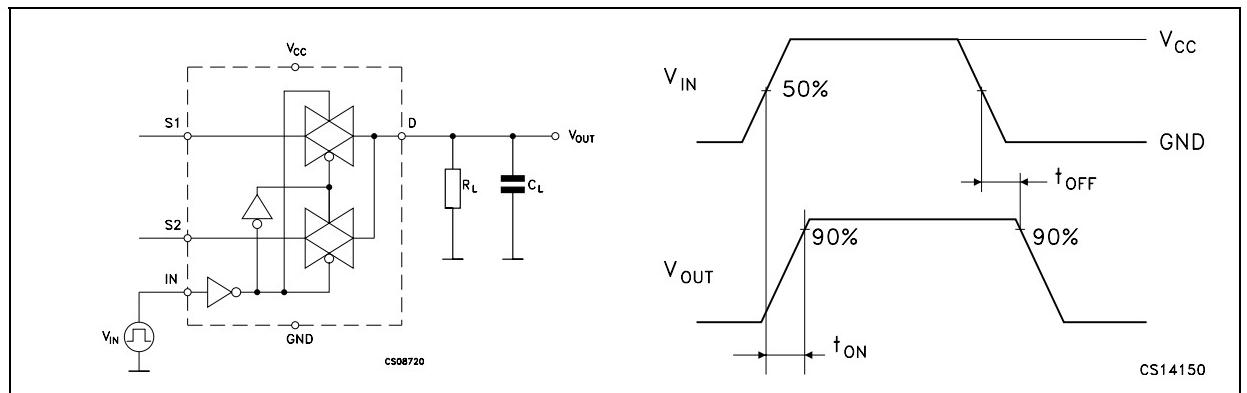
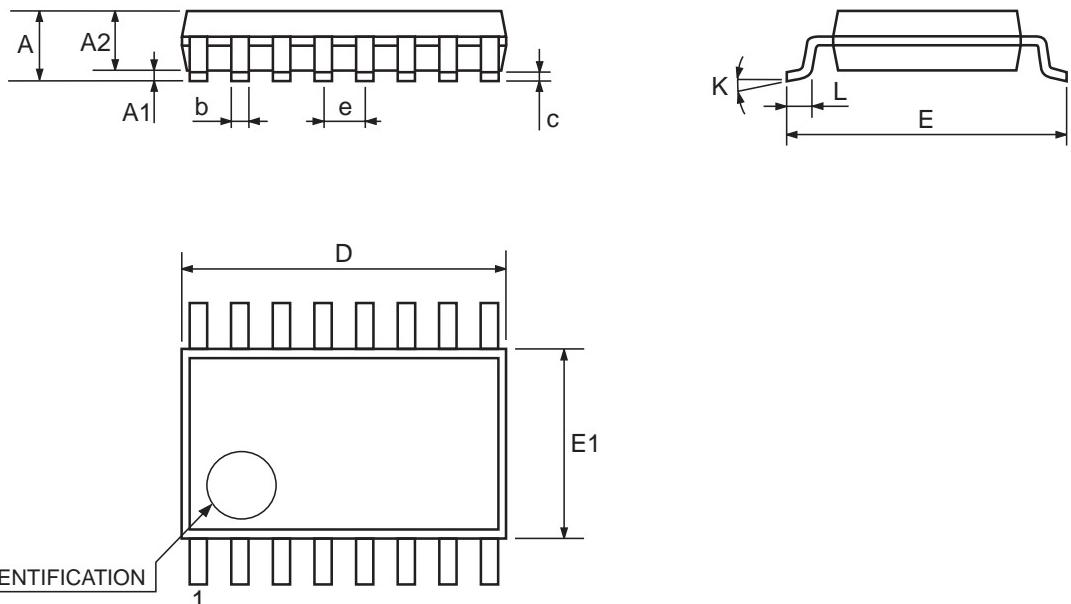


Figure 11: Turn On, Turn Off Delay Time

TSSOP16 MECHANICAL DATA

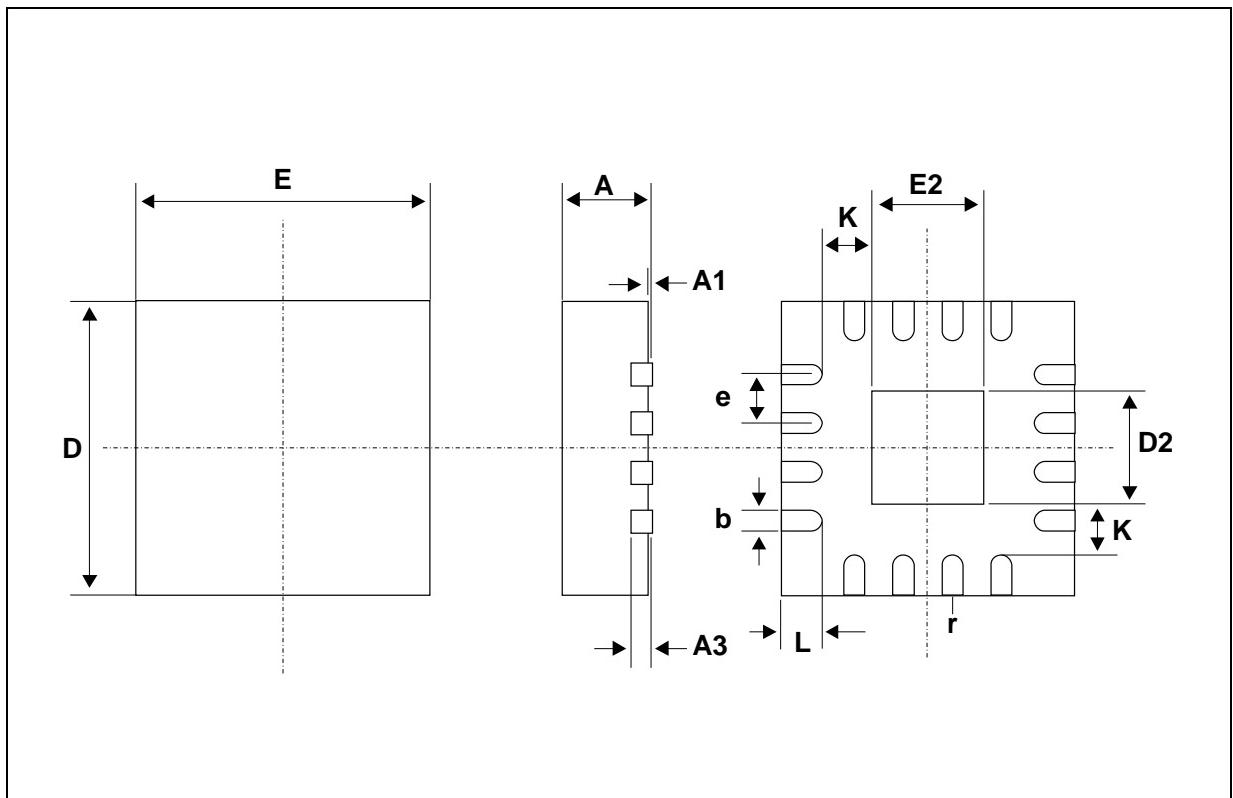
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0079
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



0080338D

QFN16 (3x3) MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	0.80	0.90	1.00	0.032	0.035	0.039
A1		0.02	0.05		0.001	0.002
A3		0.20			0.008	
b	0.18	0.25	0.30	0.007	0.010	0.012
D		3.00			0.118	
D2	1.55	1.70	1.80	0.061	0.067	0.071
E		3.00			0.118	
E2	1.55	1.70	1.80	0.061	0.067	0.071
e		0.50			0.020	
K		0.20			0.008	
L	0.30	0.40	0.50	0.012	0.016	0.020
r	0.09			0.006		



Tape & Reel TSSOP16 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.7		6.9	0.264		0.272
Bo	5.3		5.5	0.209		0.217
Ko	1.6		1.8	0.063		0.071
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319

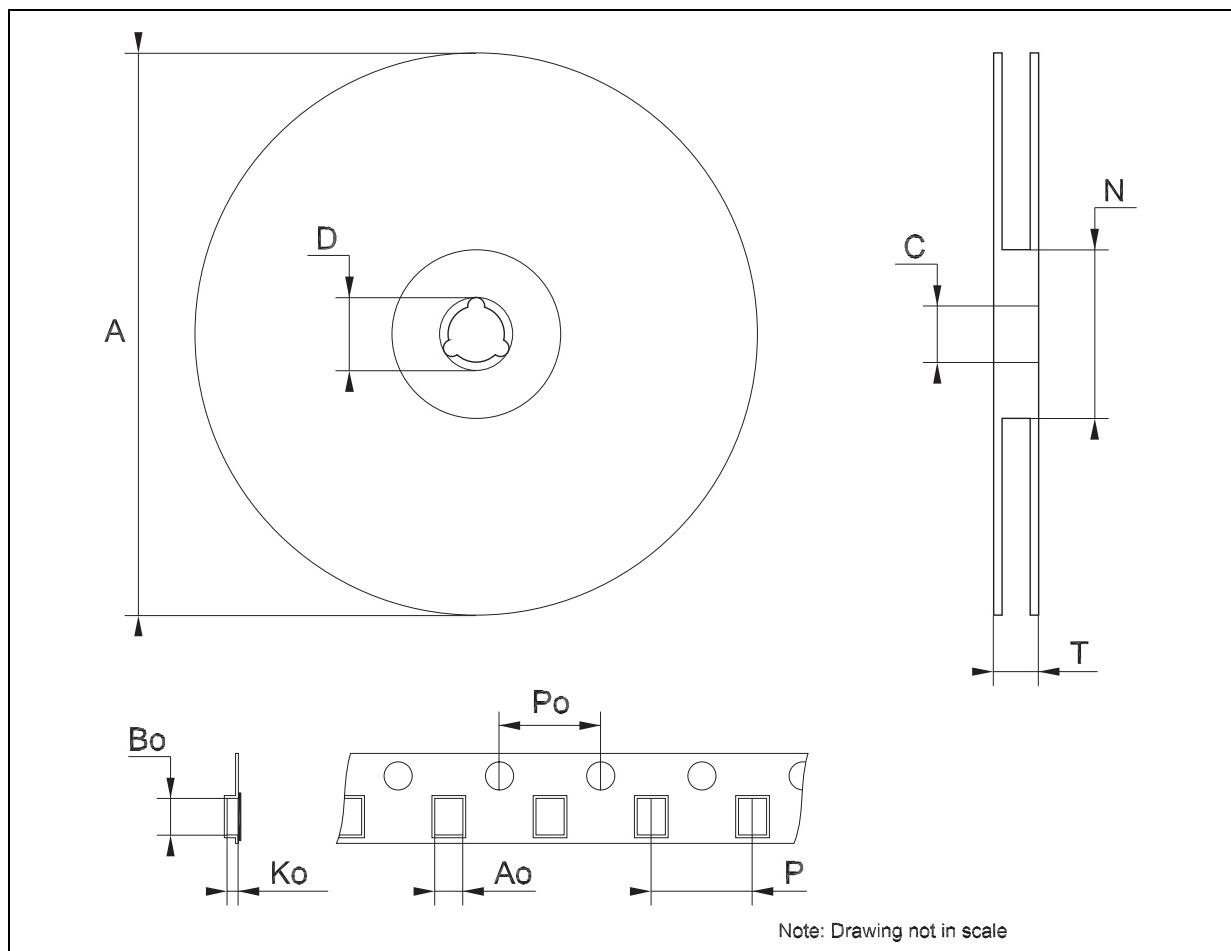


Table 9: Revision History

Date	Revision	Description of Changes
14-May-2004	3	Characteristics at $V_{CC} = 4.3$ V Added on Tables 3, 4, 5, 6 and 7.
01-Jun-2004	4	ESD Performance (Analog Channels) added on top page.
04-Jul-2005	5	The Q Values on Table 7 has been updated.

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